



Swiss engineered Products

35mm Ø Ultracapacitors

- Rated voltage 3VDC
- 330F and 360F capacitance
- Highest power density based on ultra-low ESR
- High cycle life of 1 million cycles
- Hermetically sealed cell
- Most ruggedized cell based on all laser welded design
- Radial terminals for PCB mounting



ELECTRICAL SPECIFICATIONS		
Туре	C35S-3R0-0330	C35S-3R0-0360
Rated Voltage V _R	3.00 V	3.00 V
Surge Voltage V _S ¹	3.10 V	3.10 V
Rated Capacitance C ²	330 F	360 F
Capacitance Tolerance ³	0% / +20%	0% / +20%
ESR ² (DC, 10 Hz)	<1.2 mΩ	<1.8 mΩ
ESR ² (AC, 1 kHz)	<0.9 mΩ	<1.4 mΩ
Leakage Current, typical IL ⁴	<1 mA	<1 mA
Self-discharge Rate, typical ⁵	<20%	<20%
Constant Current (ΔT = 15°C) 6	33 A	25 A
Max Current I _{Max} ⁷	355 A	329 A
Short Current I _S ⁸	2.5 kA	1.5 kA
Stored Energy E ⁹	0.4 Wh	0.45 Wh
Energy Density E _d ¹⁰	5.9 Wh/kg	6.3 Wh/kg
Usable Power DensityP _d ¹¹	13 kW/kg	7.6 kW/kg
Matched Impedance Power Density P _{dMax} ¹² , 10 Hz ESR	27 kW/kg	15.8 kW/kg
Matched Impedance Power Density P _{dMax} ¹² , 1 kHz ESR	35.7 kW/kg	22.3 kW/kg

THERMAL CHARACTERISTICS			
Туре	C35S-3R0-0330	C35S-3R0-0360	
Working Temperature	-40 ~ 65°C	-40 ~ 65°C	
Storage Temperature ¹³	-40 ~ 55°C	-40 ~ 55°C	
Thermal Resistance R _{Th} ¹⁴	11.7 K/W	11.7 K/W	
Thermal Capacitance C _{Th} ¹⁵	82 J/K	85 J/K	

LIFETIME CHARACTERISTICS			
Туре	C35S-3R0-0330	C35S-3R0-0360	
DC Life at High Temperature, 3V and 65°C ¹⁶	1500 hours	1500 hours	
DC Life at RT ¹⁷	10 years	10 years	
Cycle Life ¹⁸	1'000'000 cycles	1'000'000 cycles	
Shelf Life ¹⁹	4 years	4 years	

SAFETY & ENVIRONMENTAL SPECIFICATIONS					
Туре		C35S-3R0-0330	C35S-3R0-03	360	
Safety		RoHS, REACH and UL	810 RoHS, REACH	Hand UL810	
Vibration		ISO 16750 table 12	ISO 16750 ta	ble 12	
Shock		IEC 60068-2-27	IEC 60068-2-	27	
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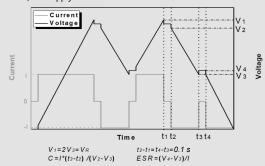




PHYSICAL PARAMETERS			
Туре	C35S-3R0-0330	C35S-3R0-0360	
Mass, typical M	70 g	72 g	
Terminals (leads)	Solderable ²¹	Solderable ²¹	
Dimensions ²⁰ Height	62.7 mm	62.7 mm	
Diameter	35.3 mm	35.3 mm	

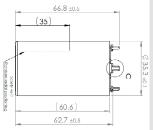
NOTES:

- 1. Surge voltage V_S : Absolute maximum voltage, non-repetitive. The duration must not exceed 1 second.
- Capacitance C: The test current is 0.1 A/F, if the calculated current is >100A, then apply 100A.



- 3. Capacitance tolerance: Initially +10%~+30%.
- 4. Leakage current measurement procedure: 1) Charge the capacitor to the V_R with a constant current (0.1 A/F, if the calculated current is >100A, then apply 100A). 2) Hold the voltage at V_R for 72h. 3) The current to maintain V_R after 72 h is the leakage current.
- 5. Self-discharge rate measurement procedure: 1) Charge the capacitor to V_R with a constant current (0.1 A/F, if the calculated current >100A, then apply 100A). 2) Hold the voltage at V_R for 8h. 3) Floating for 72h. 4) Measure the voltage after 72 h.
- 6. Max constant working current: $I_{MCC} = \sqrt{\Delta T / (ESR * R_{Th})}$
- 7. Max current: $I_{Max} = 0.5C * V_R / (\Delta t + ESR * C)$, discharge from V_R to $V_R / 2$ in 1 second.
- 8. Short current: $I_5 = V_R / ESR$
- 9. Stored energy: $E = 0.5C * V^2/3600$
- 10. Energy density: $E_d = E/M$
- 11. Usable power density: $P_d = (0.12V_R^2/ESR)/M$
- 12. Matched impedance power density: $P_{dMax} = (0.25V_R^2/ESR)/M$
- 13. Storage temperature: Storage in discharge state
- 14. Thermal resistance: $R_{Th} = \Delta T/P$, where P = ESR * I^2
- 15. Thermal capacitance: For the whole capacitor
- 16. DC life at high temperature: Hold the capacitor charged at specified voltage and temperature. The capacitance shall be >80% of the rated value, the ESR shall be <200% of the rated value.</p>
- 17. DC life at RT: Hold the capacitor charged at rated voltage at room temperature RT, the capacitance shall be >80% of the rated value, the ESR shall be <200% of the rated value.</p>
- Cycle life: Charge and discharged the capacitor in the range between V_R and V_R/2. 5 seconds waiting period between charge and discharge. The constant test current is 0.1 A/F (if the calculated current >100A, then apply 100A).
- 19. Shelf life: Discharged and no load applied at RT.

20. Dimensions, PCB drilling pattern and potential indication:



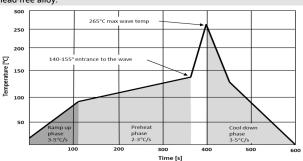


Standard markings:

- + Name of manufacturer, part number, serial number
- + Rated voltage and capacitance, positive terminals, warning marking
- + Stored energy in watt-hours

Mounting recommendations:

- + Mounting without applying undue mechanical stress on the terminals
- + Provide adequate spacing in between cells to secure required insulation strength
- + Provide clearance around the safety vent and do not position anything next to the safety vent that may be damaged in an event of vent rupture
- 21. Recommended wave soldering profile for printed circuit assembly with use of lead-free alloy:



Total soldering process time from room temperature to peak temperature 265°C and cool down is 10 minutes max. The time to reach the required temperatures depends on the design of the application and on the power of pre-heating section of the soldering machine. All temperatures are measured on the cell leads on top of the PCB. Recommended thickness for PCB = 2.4 to 3.2 mm.

Solder: Lead-free (Sn96.5/Ag 3.0/Cu0.5) liquidus point 217°C

Recommended Flux Kester 979T Ramp Up Rate: 3°-5° C/sec. Max

Preheat: 140° to 155° C 2°-3° C/sec on top of board

Temperature entrance into wave: 140° to 155° C on top of board Ramp to peak temp: 200°C/sec

Peak Temp: 265°C for 1.5 to 5 sec. Max
Cool Down Rate: 3°C-5°C /sec. Max
Convevor Speed: 40-50 cm/min

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